L Number	Hits	Search Text	DB Time stamp		
1	169	257/667.ccls.	USPAT	2002/05/23 13:45	
2	5	5844319.URPN.	USPAT	2002/05/23 13:43	
3	133		USPAT	2002/05/23 14:42	
4	356	(chip or die) and (dam or frame or ring)	USPAT	2002/05/23 14:01	
)	and underfill		j	
5	1	((chip or die) and (dam or frame or ring)	USPAT	2002/05/23 14:01	
		and underfill) and (angle same stress)			
6	77	((chip or die) and (dam or frame or ring)	USPAT	2002/05/23 14:02	
		and underfill) and angle			
7	0		USPAT	2002/05/23 14:44	
8	199		USPAT	2002/05/23 15:13	
9	5	("4897918" "5388327" "5490324"	USPAT	2002/05/23 14:51	
1.0		"5594275" "5990565").PN.	710D7 E	0000 /05 /00 15 15	
10	444	(chip or die) and ((dam or corral or ring or frame) with (underfill or encapsulant))	USPAT	2002/05/23 15:17	
11	0	(wetting adj angle) and ((dam or corral or	USPAT	2002/05/23 15:18	
1.7		ring or frame) with (underfill or	USFAI	2002/03/23 13:18	
		encapsulant))			
12	557	(wetting adj angle)	USPAT	2002/05/23 15:18	
13	2	(wetting adj angle) same dam	USPAT	2002/05/23 15:21	
14	154	((wetting or wet) adj angle) and (dam or	USPAT	2002/05/23 15:29	
		corral or ring or frame)		2002,00,20 2012	
15	3823	(cure or curing) with (dam or corral or	USPAT	2002/05/23 15:30	
		ring or frame)			
16	150	(cure or curing) with dam	USPAT	2002/05/23 16:03	
17	102	(cure or curing) with dam	US-PGPUB;	2002/05/23 16:21	
		-	EPO; JPO;		
			DERWENT;		
			IBM_TDB		
18	19293	257/787.ccls. amd dam	US-PGPUB;	2002/05/23 16:22	
			EPO; JPO;		
			DERWENT;		
			IBM_TDB		
19	28	257/787.ccls. and dam #	US-PGPUB;	2002/05/23 16:37	
			EPO; JPO;		
			DERWENT;		
20	447	/wat an watting) add angle	IBM_TDB	2002/05/23 17:00	
20	447	(wet or wetting) adj angle	US-PGPUB; EPO; JPO;	2002/03/23 17:00	
			DERWENT;		
			IBM TDB		
21	3	((wet or wetting) adj angle) and (dam or	US-PGPUB;	2002/05/23 16:46	
		underfill)	EPO; JPO;		
			DERWENT;		
			IBM TDB		
22	20		US-PGPUB;	2002/05/23 16:48	
		corral or ring or frame)	EPO; JPO;		
1			DERWENT;		
			IBM_TDB		
23	27	((wet or wetting) adj angle) and resin	US-PGPUB;	2002/05/23 16:56	
			EPO; JPO;		
			DERWENT;		
		400 /106	IBM_TDB	2002/05/02 16:56	
24	1070	438/106.ccls.	US-PGPUB;	2002/05/23 16:56	
			EPO; JPO;		
		0	DERWENT; IBM TDB		
25	61	438/108.ccls.	US-PGPUB;	2002/05/23 16:57	
2.5	01	430/100.0015.	EPO; JPO;	2002,03,23 10.3,	
			DERWENT;		
			IBM TDB	1	
26	37	((wet or wetting) adj angle) and degree	US-PGPUB;	2002/05/23 17:00	
	1	, <u>,</u>	EPO; JPO;		
1			DERWENT;		
			IBM_TDB		
27	10	((wet or wetting) adj angle) with degree	US-PGPUB;	2002/05/23 17:01	
			EPO; JPO;		
			DERWENT;		
		•	IBM TDB		

28	93	((wet or wetting)	adj angle)	and (degrees	US-PGPUB;	2002/05/23 17:03
		or degree)		0	EPO; JPO;	
					DERWENT;	
	1				TRM TDB	